

SUNCUP

Asset No. A218200/2011/100400
SAP Asset No. 700000054927
SAP Equipment No. 1000527467

EQUIPMENT DESCRIPTION

NBT SUNCUP

Manual Electroplating System

Manufacturer: NBT

Year of manufacturing: 2011

Used for Sn plating

- Semi Cup 8" for electroplating 8" wafers, including pump
- heating
- anode basket for soluble anodes
- single side/backside dry processing
- no need for backside protection -> high flexibility in chemical processing
- lab tool version - small foot print fits into standard exhaust
- very suitable for engineering and process fine tuning
- lean manufacturing and scalability for production tool

Dimensions / Weight (approx. values)

610 / 710 / 740

17kg without power supply

EQUIPMENT STATUS

in storage

Equipment is decommissioned in storage since 2017. Before operation cleaning and maintenance as well as repair might be required. System will be sold where is and as is. We offer inspection of the tool in our warehouse prior buying.